# DATA SHEET



# GaAs INTEGRATED CIRCUIT $\mu PG2031TQ$

#### L-BAND SP3T SWITCH

#### **DESCRIPTION**

The  $\mu$ PG2031TQ is an L-band SP3T GaAs FET switch which was developed for CDMA/PCS/GPS triple mode digital cellular telephone application. The device can operate from 500 MHz to 2.0 GHz, having the low insertion loss and high linality.

#### **FEATURES**

• Low insertion loss : Lins = 0.45 dB TYP. @  $V_{cont}$  = 2.8 V/0 V, f = 1.0 GHz

: LINS = 0.55 dB TYP. @  $V_{cont} = 2.8 \text{ V/0 V}$ , f = 2.0 GHz

• High isolation : ISL = 21 dB TYP. @  $V_{cont}$  = 2.8 V/0 V, f = 2.0 GHz

• High power :  $P_{in}$  (0.1 dB) = 33.0 dBm TYP. @  $V_{cont}$  = 2.8 V/0 V, f = 1.0 GHz

High-density surface mounting: 10-pin plastic TSON package (2.30 × 2.55 × 0.60 mm)

#### **APPLICATION**

• CDMA/PCS/GPS triple mode digital cellular telephone etc.

#### **ORDERING INFORMATION**

Part Number	Package	Marking	Supplying Form
μPG2031TQ-E1	10-pin plastic TSON	2031	Embossed tape 8 mm wide     Pin 5, 6 face the perforation side of the tape     Qty 3 kpcs/reel

Remark To order evaluation samples, contact your nearby sales office.

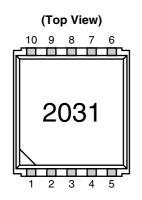
Part number for sample order: µPG2031TQ

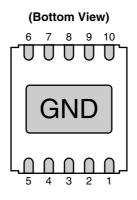
Caution Observe precautions when handling because these devices are sensitive to electrostatic discharge.

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#### PIN CONNECTIONS AND INTERNAL BLOCK DIAGRAM





Pin No.	Pin Name	
1	RF1	
2	GND	
3	RF2	
4	V <sub>cont2</sub>	
5	RF3	
6	V <sub>cont3</sub>	
7	GND	
8	ANT	
9	GND	
10	V <sub>cont1</sub>	

# ABSOLUTE MAXIMUM RATINGS (Ta = +25°C, unless otherwise specified)

Parameter	Symbol	Ratings	Unit
Switch Control Voltage	Vcont	-6.0 to +6.0	٧
Input Power	Pin	+36	dBm
Operating Ambient Temperature	TA	-45 to +85	°C
Storage Temperature	T <sub>stg</sub>	-55 to +150	°C

# RECOMMENDED OPERATING RANGE (TA = +25°C)

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
Switch Control Voltage (High)	V <sub>cont (H)</sub>	2.7	2.8	3.0	V
Switch Control Voltage (Low)	V <sub>cont (L)</sub>	-0.2	0	0.2	V

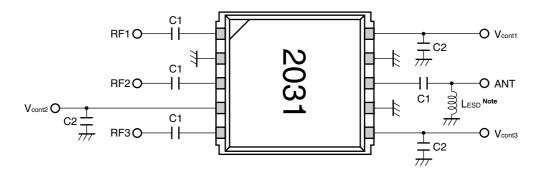


# ELECTRICAL CHARACTERISTICS (TA = +25°C, $V_{cont}$ = 2.8 V/0 V, $Z_0$ = 50 $\Omega$ , off chip DC blocking capacitors value: 56 pF, unless otherwise specified)

Parameter	Symbol	ON-Pass	Test Conditions	MIN.	TYP.	MAX.	Unit
Insertion Loss	Lins	ANT-RF1/2/3	f = 0.5 to 1.0 GHz	_	0.45	0.65	dB
			f = 1.0 to 2.0 GHz	_	0.55	0.80	dB
Isolation	ISL	ANT-RF1/2/3	f = 0.5 to 1.0 GHz	22	26	-	dB
		(OFF)	f = 1.0 to 2.0 GHz	17	21	-	dB
Input Return Loss	RLin	ANT-RF1/2/3	f = 0.5 to 2.0 GHz	15	20	1	dB
Output Return Loss	RLout	ANT-RF1/2/3	f = 0.5 to 2.0 GHz	15	20	-	dB
0.1 dB Gain Compression Input Power	Pin (0.1 dB)	ANT-RF1/2/3	f = 1.0 GHz	31.0	33.0	-	dBm
2nd Harmonics	2f0	ANT-RF1/2/3	f = 1.0 GHz, Pin = 27 dBm	65	75	-	dBc
3rd Harmonics	3f0	ANT-RF1/2/3	f = 1.0 GHz, P <sub>in</sub> = 27 dBm	65	75	-	dBc
Switch Control Speed	tsw			-	150	-	ns
Switch Control Current	Icont		RF Non	-	1	50	μΑ

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#### **EVALUATION CIRCUIT**



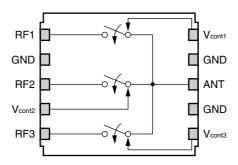
**Note** Recommend attached Lesp to antenna port for ESD protection.

The application circuits and their parameters are for reference only and are not intended for use in actual design-ins.

#### USING THE NEC EVALUATION BOARD

Symbol	Values		
C1	56 pF		
C2	1 000 pF		

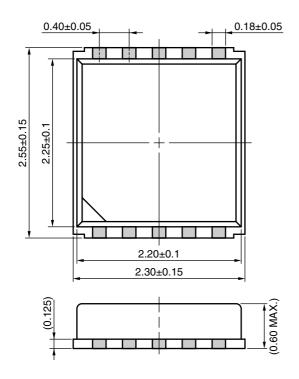
#### TRUTH TABLE

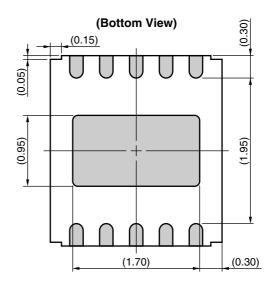


V <sub>cont1</sub>	V <sub>cont2</sub>	V <sub>cont3</sub>	ANT-RF1	ANT-RF2	ANT-RF3
High	Low	Low	ON	OFF	OFF
Low	High	Low	OFF	ON	OFF
Low	Low	High	OFF	OFF	ON

# **PACKAGE DIMENSIONS**

# 10-PIN PLASTIC TSON (UNIT: mm)





Remark ( ): Reference value

#### RECOMMENDED SOLDERING CONDITIONS

This product should be soldered and mounted under the following recommended conditions. For soldering methods and conditions other than those recommended below, contact your nearby sales office.

Soldering Method	Soldering Conditions		Condition Symbol
Infrared Reflow	Peak temperature (package surface temperature) Time at peak temperature Time at temperature of 220°C or higher Preheating time at 120 to 180°C Maximum number of reflow processes Maximum chlorine content of rosin flux (% mass)	: 260°C or below : 10 seconds or less : 60 seconds or less : 120±30 seconds : 3 times : 0.2%(Wt.) or below	IR260
VPS	Peak temperature (package surface temperature) Time at temperature of 200°C or higher Preheating time at 120 to 150°C Maximum number of reflow processes Maximum chlorine content of rosin flux (% mass)	: 215°C or below : 25 to 40 seconds : 30 to 60 seconds : 3 times : 0.2%(Wt.) or below	VP215
Wave Soldering	Peak temperature (molten solder temperature) Time at peak temperature Preheating temperature (package surface temperature) Maximum number of flow processes Maximum chlorine content of rosin flux (% mass)	: 260°C or below : 10 seconds or less : 120°C or below : 1 time : 0.2%(Wt.) or below	WS260
Partial Heating	Peak temperature (pin temperature) Soldering time (per side of device) Maximum chlorine content of rosin flux (% mass)	: 350°C or below : 3 seconds or less : 0.2%(Wt.) or below	HS350

Caution Do not use different soldering methods together (except for partial heating).

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#### Caution

GaAs Products

This product uses gallium arsenide (GaAs).

GaAs vapor and powder are hazardous to human health if inhaled or ingested, so please observe the following points.

- Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below.
  - Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials.
  - 2. Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal.
- Do not burn, destroy, cut, crush, or chemically dissolve the product.
- Do not lick the product or in any way allow it to enter the mouth.

#### ▶ For further information, please contact

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